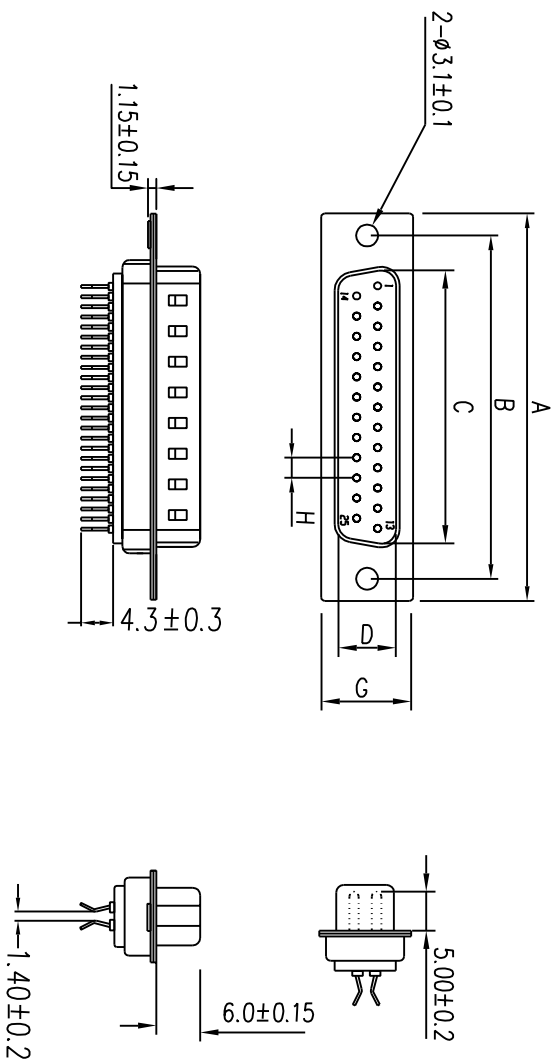


REV.	ENJ NO	LOCATIONS	DESCRIPTION	DATE	REWSEK	APPO



Note:

1.Material:

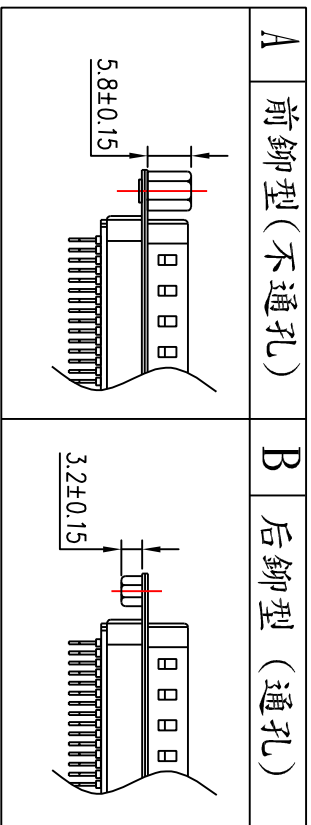
- 1.1 Insulator: P.B.T UL 94-V0 rated.
- 1.2 Contact: Copper alloy,t=0.20mm.
- 1.3 Shell: Cold rolled steel,t=0.40mm.

2.Specification:

- 2.1 Current rating: 1 A Max.
- 2.2 Dielectric withstanding voltage: 500 V(ac) for 1 minute.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 1000 MΩ Min at DC 500V.
- 2.5 Total mating force: 8.0 Kgf Max.
- 2.6 Total unmating force: 1.5 Kgf Min.
- 2.7 Temperature range: -55°C~+105°C

3.Finishes:

- 3.1 contacts:Gold flashed 1u",3u",5u",10U",15u",30u".
- 3.2 Shell: Nickel,tin or gold plated



PART NO	A±0.25	B±0.20	C±0.20	D±0.20	G±0.25	H±0.05
DS-09P	30.81	24.99	16.92	8.38	12.55	2.77
DS-15P	39.25	33.32	25.25	8.38	12.55	2.77
DS-25P	53.04	47.04	38.96	8.38	12.55	2.77
DS-37P	69.50	63.50	55.42	8.38	12.55	2.77

4	Back-shell	1	Cold Rolled Steel	T=0.40mm	Tin Plated
3	Front-shell	1	Cold Rolled Steel	T=0.40mm	Nickel Plated
2	Contact	9-37	Copper alloy	T=0.20mm	Gold Plated
1	Housing	2	P.B.T	UL 94-V0	Black/Blue/White
No.	Part Name	Qty	Material	Remarks & Thickness	Finish

HSI-CHIN ELECTRONICS CO.,LTD

MODEL NO:	FINISH:	PART NAME:	
UNIT: mm	SIZE: A4	D-SUB SOLDER (M) CP	
TOLERANCE UNSPECIFIED	DR: <i>Ophawa</i>	DWG NO:	REV: A0
.x ±0.3	CHK: <i>Nick</i>	HC-001-02	SCALE: 1:1
.xx ±0.20	APP: <i>Kend</i>	SHEET: 1 of 1	
.xxx ±0.100			
ANG ±1°			

PART NO:	MATERIAL:	REMARKS: